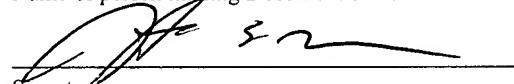


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of:)
Yves Lüthi)
)
MMB Docket No. 1867-0037) Examiner: **To be assigned**
)
Application No. **To be assigned**) Group Art Unit: **To be assigned**
)
Filed: **Herewith**)
)
For: **Moisture Sensor With Capacitive Moisture Measuring Element**
and Method of Determining Air Humidity

“Express Mail” Mailing Label Number EV 162784898 US
I hereby certify that this correspondence is being deposited with
the United States Postal Service “Express Mail Post Office to
Addressee” service under 37 CFR §1.10 on the date indicated
below and is addressed to: Mail Stop Patent Application,
Commissioner for Patents, P.O. Box 1450, Alexandria, VA
22313-1450 on October 13, 2003
Date of Deposit)

Harold C. Moore
Name of person mailing Document or Fee

Signature

October 13, 2003
Date of Signature

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 CFR §1.56, Applicant hereby discloses the following references,
copies of which are enclosed, regarding the above-identified patent application.

U.S. Patent No.
5,844,138

Issue Date
December 1, 1998

Inventor
Cota

Articles

1. Chen, Zhi, Mao-Chang Jin and Chao Zhen, "Humidity Sensors With Reactively Evaporated Al₂O₃ Films as Porous Dielectrics," Sensors and Actuators B Chemical, August 1990, (5 pages).
2. Li, G. Q., P. T. Lai, M. Q. Huang, S. H. Zeng, B. Li and Y. C. Cheng, "A Humidity-Sensing Model for Metal-Insulator-Semiconductor Capacitors with Porous Ceramic Film," Journal of Applied Physics, June 15, 2000, (5 pages).
3. Denton, Denice D., Maha A. S. Jaafar, Andrew R. K. Ralston, Choon Ngiap Ho, and I Li Sen-gang, "The Long Term Reliability of a Switched-Capacitor Relative Humidity Sensor System," University of Wisconsin-Madison, (4 pages).
4. Dokmeci, Mehmet and Khalil Najafi, "A High-Sensitivity Polyimide Capacitive Relative Humidity Sensor for Monitoring Anodically Bonded Hermetic Micropackages," Journal of Microelectromechanical Systems, Vol. 10, No. 2, June 2001, (8 pages).
5. Visscher, G. J. W. and J. G. Kornet, "Long-Term Tests of Capacitive Humidity Sensors," Measurement Science & Technology, October 1994, (9 pages).
6. Anchisini R., G. Faglia, M. C. Gallazzi, G. Sberveglieri, and G. Zerbi, "Polyphosphazene Membrane as a Very Sensitive Resistive and Capacitive Humidity Sensor," Sensors and Actuators B Chemical, 1996, (4 pages).

Commissioner for Patents

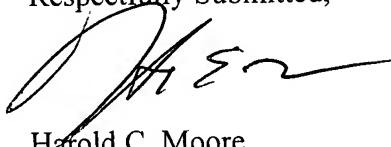
October 13, 2003

Page 3 of 3

It is believed that no fees are due for the consideration of this Information Disclosure Statement. However, the Commissioner is hereby authorized to charge any deficiency or to credit any overpayment to Deposit Account No. 13-0014, but not to include any payment of issue fees.

October 13, 2003
Maginot, Moore & Beck
Bank One Center Tower
111 Monument Circle, Suite 3000
Indianapolis, Indiana 46204-5115
(317) 638-2922

Respectfully Submitted,



Harold C. Moore
Attorney for Applicant
Registration No. 37,892

FORM PTO-1449 INFORMATION DISCLOSURE STATEMENT	MMB DOCKET NO. 1867-0037 Siemens Docket No. 2002P17239US	APPLICATION NO.: To be assigned
	APPLICANT(S): Lves Lüthi	
	FILING DATE: Herewith	GROUP ART UNIT: To be assigned

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB-CLASS	FILING DATE
	AA	5,844,138	12/01/1998	Cota			
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATION
	AL						Yes No
	AM						Yes No
	AN						Yes No
	AO						Yes No
	AP						Yes No
OTHER (Including Author, Title, Date, Pertinent Pages, etc.)							
	AQ	1	Chen, Zhi, Mao-Chang Jin and Chao Zhen, "Humidity Sensors With Reactively Evaporated Al ₂ O ₃ Films as Porous Dielectrics," Sensors and Actuators B Chemical, August 1990, (5 pages).				
	AR	1	Li, G. Q., P. T. Lai, M. Q. Huang, S. H. Zeng, B. Li and Y. C. Cheng, "A Humidity-Sensing Model for Metal-Insulator-Semiconductor Capacitors with Porous Ceramic Film," Journal of Applied Physics, June 15, 2000, (5 pages).				
	AS	1	Denton, Denice D., Maha A. S. Jaafar, Andrew R. K. Ralston, Choon Ngiap Ho, and I Li Sen-gang, "The Long Term Reliability of a Switched-Capacitor Relative Humidity Sensor System," University of Wisconsin-Madison, (4 pages).				
EXAMINER					DATE CONSIDERED		
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicants.							

FORM PTO-1449 INFORMATION DISCLOSURE STATEMENT	MMB DOCKET NO. 1867-0037 Siemens Docket No. 2002P17239US	APPLICATION NO.: To be assigned
	APPLICANT(S): Lves Lüthi	
	FILING DATE: Herewith	GROUP ART UNIT: To be assigned

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB-CLASS	FILING DATE
	BA						
	BB						
	BC						
	BD						
	BE						
	BF						
	BG						
	BH						
	BI						
	BJ						
	BK						

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATION
	BL						Yes No
	BM						Yes No
	BN						Yes No
	BO						Yes No
	BP						Yes No

OTHER (Including Author, Title, Date, Pertinent Pages, etc.)

	BQ	2	Dokmeci, Mehmet and Khalil Najafi, "A High-Sensitivity Polyimide Capacitive Relative Humidity Sensor for Monitoring Anodically Bonded Hermetic Micropackages," Journal of Microelectromechanical Systems, Vol. 10, No. 2, June 2001, (8 pages).
	BR	2	Visscher, G. J. W. and J. G. Kornet, "Long-Term Tests of Capacitive Humidity Sensors," Measurement Science & Technology, October 1994, (9 pages).
	BS	2	Anchisini R., G. Faglia, M. C. Gallazzi, G. Sberveglieri, and G. Zerbi, "Polyphosphazene Membrane as a Very Sensitive Resistive and Capacitive Humidity Sensor," Sensors and Actuators B Chemical, 1996 (4 pages).

EXAMINER	DATE CONSIDERED
----------	-----------------

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicants.